

ADVANCED PROCESSING APPARATUS COMPRISING A PLURALITY OF QUANTUM PROCESSING
ELEMENTSField of the Invention

The present invention relates to an advanced processing apparatus comprising quantum processing elements, and
5 particularly, but not exclusively, to an architecture for performing quantum processing.

Background of the Invention

The power and capacity of computing components such as microprocessors and memory circuits has been increasing
10 for the last 50 years, as the size of the functional units, such as transistors, has been decreasing. This trend is now reaching a limit, however, as it is difficult to make the current functional units (such as MOSFETs) any smaller without affecting their operation.

15 The technology employed to manufacture conventional silicon integrated circuits has developed over the last 50 years and is today well established. Current microprocessors feature several hundreds of millions of transistors which are manufactured in high-throughput
20 lines.

Developments are ongoing to implement new types of advanced processing apparatus that can implement powerful computations using a different approach than current processors. Such advanced processing apparatus promise
25 computational capacities well beyond current devices. For example, quantum processors are being developed which can perform computations according to the rules of quantum mechanics. Approaches to the realisation of devices for

implementing quantum bits (qubits), the basic computational unit of a quantum processor, and quantum architectures, have been explored with different levels of success.

- 5 The most promising routes towards large-scale universal quantum computing all require quantum error correction, a technique that enables the simulation of ideal quantum computation using realistic noisy qubits, provided that the noise is below a fault-tolerant threshold.
- 10 Some quantum error correction methods, such as the 'surface code', allow for error thresholds as high as 1%. Such errors levels can be achieved using a number of qubit platforms. However, the implementation of the surface code requires a large number of qubits and therefore a platform
- 15 that can be scaled-up to a large number of qubits, such as 10^8 . The requirement for such a large number of qubits creates a challenge in the field of quantum computing, even for the most promising platforms.

- In order to manufacture an 'error-corrected quantum
- 20 computer', a scalable architecture is required. Such architecture would ideally incorporate large numbers of qubits, disposed in relatively close proximity to each other, operating in synergy to implement error-corrected quantum computation. In addition, the architecture should
- 25 be feasible to manufacture.

Summary of the Invention

In accordance with the first aspect, the present invention provides an advanced processing apparatus, comprising:

a plurality of quantum processing elements arranged in a matrix; each processing element comprising silicon and a dielectric material forming an interface and an electrode arrangement suitable to confine one or more
5 electrons or holes in the silicon to form a quantum dot operable as a qubit;

a plurality of control members disposed about the processing elements; each control member comprising one or more switches arranged to interact with the electrode
10 arrangement to perform quantum operations with the processing element; and

a plurality of control lines; each control line being connected to a plurality of control members to enable simultaneous operation of a plurality of processing
15 elements.

The quantum operations may comprise any one of initialisation, quantum control and readout of the processing element.

In an embodiment, the electrode arrangement comprises one
20 or more electrodes which are controllable to form the quantum dot and operate the quantum dot as a qubit.

In an embodiment, the one or more switches comprise integrated transistors which interact with electrodes of the electrode arrangement. The transistors may be field
25 effect transistors. Alternatively, magnetic switches may be used to interact with electrodes of the electrode arrangement.

Advantageously, the processing elements may be arranged in a 2D matrix along an interface which is formed between a

silicon layer and a dielectric layer. The interface, the silicon layer and the dielectric layer may be shared by the processing elements. The electrode arrangement may be disposed onto the dielectric layer and the quantum dot
5 formed in proximity of the interface. The electrodes and the control members may have a three-dimensional structure and extend in a direction perpendicular to the interface. In embodiments, the control members are disposed in a section of the apparatus above the electrode arrangement.

10 In an embodiment, each processing element of the apparatus is associated with at least two control members.

The first control member may be arranged to provide a biasing voltage to form the quantum dot and the second control member may be arranged to operate the quantum dot
15 as a qubit. The biasing voltage applied to the first control member may be tuned to calibrate the processing element and ensure that the processing elements in the matrix are in the same initial condition.

In embodiments, each control line is oriented along a row
20 or a column of the 2D matrix of processing elements and is capable of interacting with all the processing elements disposed along the row or column.

The control lines may be arranged in a manner such that the biasing voltage is applicable to the first control
25 member of selected processing elements to form the quantum dots, and also to select the processing element for quantum operation. Further, the control lines may be arranged in a manner such that a control voltage is applicable to the second control member of the selected
30 processing elements to operate the qubits.

The control lines may be also be operated to facilitate exchange coupling between two processing elements disposed at two locations of the matrix. In addition, the control lines may be arranged to facilitate capacitive coupling
5 between two processing elements disposed at two locations of the matrix. The two locations may be neighbouring locations.

In some instances, a multiplexing assembly may be used to multiplex a plurality of control lines.

- 10 In some embodiments, the apparatus further comprises transistors arranged to provide classical computing capabilities to the apparatus. These transistors may be also used to compute a portion of a problem which cannot be computed using the matrix of processing elements.
- 15 Classical computing capabilities may also be provided by an external classical processing apparatus.

In some embodiments, the electrode arrangement is operable to form the quantum dot and tune the quantum dot so that the energy at which the state of the qubit is affected can
20 be adjusted over a range of energy values. The electrode arrangement may be also operable to control a quantum property of the quantum dot, such as electron or hole spin, to operate the quantum dot as a qubit.

The qubit logic states may be controlled by voltages
25 applied to the electrode arrangement to tune an exchange interaction between spins of electrons or holes of the quantum dots, or to tune a capacitive interaction between one or more electrons or holes. The electrode arrangement may be operable to tune the electron or hole spin
30 resonance frequency of the quantum dot and/or electrically

drive the electron or hole spin resonance frequency of the quantum dot.

In embodiments, the electrode arrangement is arranged to confine electrons or holes in the silicon to form at least
5 two quantum dots for encoding qubit logic states.

Furthermore, the apparatus may comprise a generator for bathing the processing elements in electromagnetic radiation for affecting the spin of the electrons or holes.

10 In embodiments, the dielectric material comprises silicon dioxide and the silicon comprises predominantly ^{28}Si .

In accordance with the second aspect, the present invention provides an advanced processing apparatus comprising a plurality of multi-qubit modules; each multi-
15 qubit module comprising an apparatus in accordance with the first aspect. The plurality of multi-qubit modules may be interconnected by interconnecting members which may comprise superconducting resonators or spin-buses.

Advantageously, this configuration allows to implement an
20 advanced processing apparatus with a large number of quantum bits. Dividing the qubits in modules allows managing the level of complexity of the control lines for each module.

In accordance with the third aspect, the present invention
25 provides a method for operating an advanced processing apparatus in accordance with any one of the preceding claims; the method comprising the steps of:

applying electrical signals to a plurality of control lines to initialise at least a portion of the processing elements;

5 applying electrical signals to a plurality of control lines to select a plurality of processing elements for quantum operation;

applying electrical signals to a plurality of control lines to perform quantum operations using selected processing elements;

10 applying electrical signals to a plurality of control lines to readout the quantum state of selected processing elements.

In embodiments, the method further comprises the step of applying electrical signals to a plurality of control
15 lines to calibrate the processing elements and to form quantum dots for each of the processing elements.

In accordance with the fourth aspect, the present invention provides an advanced processing apparatus in accordance with the first aspect or the second aspect and
20 a classical computing apparatus, wherein the classical computing apparatus controls the advanced processing apparatus to perform a quantum algorithm.

In some embodiments, the advanced processing apparatus and the classical computing apparatus can work in synergy to
25 compute a solution of a computing problem.

In accordance with the fifth aspect, the present invention provides an advanced processing apparatus, comprising:

a plurality of quantum processing elements
arranged in a 2D matrix; and

a plurality of control members comprising silicon
field effect transistors disposed above the quantum
5 processing elements and interconnected to form a matrix of
control members;

wherein the field effect transistors are arranged
to operate the quantum processing elements to enable
quantum processing.

10 In accordance with the sixth aspect, the present invention
provides a method for manufacturing an advanced processing
apparatus comprising the steps of:

providing a silicon substrate;

forming a silicon 28 layer;

15 forming a dielectric layer in a manner such that
the dielectric layer and the silicon 28 layer form an
interface;

forming a plurality of electrodes suitable to
confine one or more electrons or holes about the interface
20 to define a plurality of quantum dots operable as a
qubits;

forming a plurality of control members comprising
switches arranged to interact with the plurality of
electrodes; and

25 forming a plurality of control lines; each
control line being connected to one or more control

members to enable simultaneous operation of a plurality of processing elements;

wherein the plurality of electrodes, control members and control lines are formed by using a MOS
5 manufacturing process.

In accordance with the seventh aspect, the present invention provides an advanced processing apparatus, comprising:

a 2D array of quantum processing elements; and
10 a plurality of control members comprising field effect transistors disposed above the quantum processing elements and interconnected to a plurality of control lines;

wherein the processing elements are addressable
15 via the control lines using a DRAM addressing technique.

Advantageous embodiments of the present invention provide a quantum processing architecture comprising a matrix of quantum processing devices. The quantum processing devices use the quantum properties of electrons or holes confined
20 in proximity of a silicon/silicon dioxide interface to implement qubits. The apparatus comprises an electrode arrangement used to confine the electrons or holes and operate the qubit, control members and control lines which can be used to address multiple qubits at the same time.

25 Advantageously, the architecture is realised in silicon and can potentially be manufactured using techniques which are compatible with current silicon microelectronic

fabrication technologies and CMOS nodes. This makes the architecture easy to scale to large numbers of qubits.

Brief Description of the Drawings

Features and advantages of the present invention will
5 become apparent from the following description of
embodiments thereof, by way of example only, with
reference to the accompanying drawings, in which;

Figure 1 shows schematic views of a processing element of
the apparatus in accordance with embodiments;

10 Figure 2 shows a stack of layers for manufacturing an
architecture in accordance with embodiments (a) and a
simplified schematic of control lines used to control
qubits (b).

Figure 3 is a schematic view of an electrode structure in
15 accordance with embodiments;

Figure 4, shows a schematic top view of an architectural
layout in accordance with embodiments;

Figure 5 shows two schematic cross sectional views of an
architectural layout in accordance with embodiments;

20 Figures 6 and 7 show schematic representations of a
portion of an architecture in accordance with embodiments.

Detailed Description of Embodiments

In the following description an advanced processing
apparatus and method for operating an advanced processing
25 apparatus are described. The advanced processing apparatus
comprises a plurality of quantum processing elements

arranged in a matrix. The processing elements comprise a silicon/dielectric interface and an electrode arrangement suitable to confine one or more electrons or holes in the silicon, in proximity of the interface, to form one or
5 more quantum dots which are operable as a qubit. The apparatus also comprises a plurality of control members disposed about the processing elements. The control members include switches which interact with the electrodes to enable quantum operations. A plurality of
10 control lines is connected to the control members to enable simultaneous operation of a plurality of processing elements.

Referring to figure 1, there are shown two simplified views of a processing element 100 used in the apparatus.
15 Figure 1(a) is a top view and figure 1(b) is a side cross sectional view. In the embodiment described, the processing element comprises a silicon substrate 102 and a dielectric 104, in this example being silicon dioxide. Isotopically enriched silicon ^{28}Si is used. The
20 isotopically enriched silicon ^{28}Si 102 may be an epitaxial layer grown on a conventional silicon substrate.

The implementation of a spin qubit in a silicon/silicon dioxide system provides increased spin coherence compared with most compound semiconductors due to the reduced
25 hyperfine coupling of the qubit to nuclear spins in the host crystal. The two dimensional electron gas confined at the silicon/silicon dioxide interface can be depleted to isolate quantum dots containing a small number of electrons by using an electrostatic field.

30 A first electrode 106 is operable to form a quantum dot in proximity of the interface. Figure 1(b) shows an area 110

where either electrons or holes may be isolated.
Sufficiently positive voltages applied to electrode 106
will cause electrons to be isolated in the area 110, while
sufficiently negative voltages applied to electrode 106
5 will cause holes to be isolated in area 110.

For example, a single electron can be isolated in area
110, thus forming an isolated quantum dot. A single qubit
can be encoded in the spin of the isolated electron.
Alternatively, a qubit can be encoded using the spins of
10 multiple electrons or holes in a single quantum dot.
Additional electrode structures can also be employed to
aid in confinement of the quantum dots, or form more than
one quantum dot. In an alternative embodiment, a single
qubit can be encoded on the spin of one or more electrons
15 or holes of respective one or more quantum dots. Further
elements can also be introduced at the interface to
promote electron confinement, such as doped regions or
dielectric regions. In addition, the overall concentration
of electrons at the interface may be modified using an
20 isolated global electrode above or below the interface.

Electrode 108 is arranged to interact with the quantum
dot, or quantum dots, formed using electrode 106 so that
quantum operations can be performed. The control of the
qubit is generally obtained through an electromagnetic
25 signal through electrode 108. In particular, electrode 108
can be used to readout, control and couple the respective
qubit. For example, electrode 108 can be used to control
the effective g-factor of the electrons or holes forming
the quantum dot, or quantum dots. Alternatively, electrode
30 108 can be used to directly control the spin of the
electrons or holes using an AC electric field. A DC

magnetic field is also applied to split the quantum states and thereby define the logical basis states of the qubit.

Electrode 108 is also used to facilitate coupling of different qubits via the exchange interaction or
5 capacitive interaction to perform two qubit operations.

In the scalable quantum computing architecture described herein, a large number of qubit structures configured in accordance with the principles discussed above and illustrated in figure 1, operate together to perform error
10 corrected quantum computation. Before qubit operations are performed, the qubits are tuned to have the same starting electrostatic conditions by applying a tuning potential to gate 106.

It had previously been thought that a Si/SiO₂ interface
15 would have too many defects, or that the SiO₂ would contain too many random charge centres, to allow realisation of a quantum dot that could be used as a qubit. In comparison with other semiconductor interfaces that can be used to confine quantum dots, such as the Ga/GaAs interface, the
20 Si/SiO₂ interface is a relatively high disorder environment and therefore was thought not conducive to qubit operation. This has subsequently been shown to not be the case, and good quality qubits have been recently demonstrated by the Applicants in such Si/SiO₂ systems.

25 The Applicants have also discovered that, surprisingly, the frequency of the AC electromagnetic signal required to interact with the qubit in its single electron mode can be varied by tuning the g-factor of the electron, and therefore also its Zeeman energy. The ability to tune the
30 qubit facilitates the operation of the advanced processing

apparatus and allows operating the architecture with many qubits. The qubits can be addressed or controlled by varying the effective g-factor of the electrons or holes of the qubit. This control technique allows for the
5 addressing of qubits individually or in groups.

Referring now to figure 2(a), there is shown a stack of layers 200 which can be used to manufacture a quantum computing architecture in accordance with embodiments. Structure 200 comprises an n-type doped (natural) silicon
10 202 that is used as a conductive back-plane and a SiO₂ layer 204 that is used as a template insulator layer. Isotopically purified silicon-28 206 is the host material for the qubits. Further dielectric layers 208 and
15 metallically-doped poly-silicon, or metallic, layers 210 allow forming transistors and electrodes that can be used to control the quantum bits. A further region 212 is used to host the metallic control lines to control the transistors.

Variations of materials or layer configuration could be
20 used in alternative embodiments. For example additional semiconductor layers on top of the structure could be used to allow for more components. The fabrication of these stacks can utilize technologies developed within the rapidly evolving field of three-dimensional silicon
25 integrated circuits.

Figure 2(b) shows a schematic 250 with control lines configured to control qubits. Data lines D_i (252) are interconnected to corresponding qubits Q_i (254), to tune the qubit resonance frequency (ν_i), as well as to each J-
30 gate 256 to control the exchange coupling between qubits. To provide individual, row, or global qubit addressing,

the data lines are controlled by a combination of word lines W (258) and bit lines B (260). Assuming the minimal width of, and separation between, the gates and doped regions is equal to the minimum feature size λ , the
5 classical circuit occupies an area $80\lambda^2$ per qubit. Modern large semiconductor fabrication facilities are capable of manufacturing CMOS transistors with feature size down to 7 nm. Therefore each quantum dot qubit (including half the barrier area that separates the qubits) would occupy an
10 area of $\approx 63 \text{ nm} \cdot 63 \text{ nm}$, consistent with experimental realizations of silicon quantum dot qubits.

Referring now to figure 3, there is shown a 3D schematic view 300 of a possible configuration of electrodes and respective overlaying control members 302 and 304. Control
15 member 302 comprises two transistors 306 which allow interconnecting one or more of the control lines, connected to control member 302, to the respective electrode (106). Control member 304 comprises two
20 transistors 308 which allow interconnecting one or more of the control lines, connected to control member 304, to the respective electrode (108). The control lines include word lines 312, bit lines 314 and data lines 316.

A ground plane (318) is used to avoid capacitive cross-talk and can be realised such as to have the required
25 coupling to each gate. A back electrode 320 can be used to modify the overall concentration of electrons across the interface to optimise the properties of the quantum dots.

The electrodes configuration shown in figure 3 and the structure of the respective processing element,
30 schematically shown in figure 1, are compatible with current CMOS technology nodes.

Referring now to figure 4, there is shown a schematic top view 400, of a layout of electrodes which can be used to form and control a plurality of qubits arranged in a 2D-matrix in accordance with embodiments. Electrodes 402 are
5 used to form quantum dots in the silicon 28 material 403, which is separated from the electrodes by a dielectric layer. Electrodes 404 are used to operate the quantum dots as qubits and perform quantum operations.

Figure 5(a) and figure 5(b) respectively show schematic
10 cross sectional views 510 and 550 of architectural layouts which can be used to implement the general configuration of figure 4. Structure 510 is a side view of a section of architecture 400 along dotted line 406, while structure 550 is a side view of a section of architecture 400 along
15 dotted line 408. In the architecture of figure 5 each qubit is encoded on the spin of a single quantum dot 512. The quantum dots 512 are formed using electrodes 514.

Electrodes 514 are connected to a plurality of control lines via control members comprising electronic switches,
20 provided in the form of transistors 518 and 520 (the reference numerals in figure 5 point to the channels of the transistors). The plurality of control lines comprises: bit-line 524, which can connect to electrodes 513 via the transistors 520; data-line 526, which can
25 connect to electrodes 514 via the transistors 518; and word-lines 530. Each electrode 514 can be set to the voltage of the data-line when the corresponding bit-line and word-line are set to a high voltage (digital high state).

30 A similar layout can be used to implement the electrodes which perform the quantum operations 552. These electrodes

are located, respectively, in proximity of the quantum dots and are arranged to interact with the quantum dots to perform quantum operations such as readout, control and coupling of qubits. Electrodes 552 are connected to a plurality of control lines via control members comprising electronic switches, provided in the form of transistors 570 and 572. The plurality of control lines comprises: bit-line 574, which can connect to electrodes 573 via the transistors 570; read-couple-control (RCC) line 578, which can connect to electrodes 552 via the transistors 572; and word-lines 580.

The layouts of figure 5 provide advantages for both sequentially tuning the quantum dots and for simultaneous operation. These advantages will be discussed in more detail with reference to figure 7.

Generally, the most compact classical circuits have different geometries from quantum circuits, which consist of circular (or square) qubits. The situation is further complicated by the geometrical layout of the metal lines, determined by the quantum error correction implementation. By using the interconnections layers described above, the Applicants have overcome the complexity in scaling these differently sized circuit components. As the number of qubits increases, the input region, the transistor region and the qubit region of the structure become similar in size and shape. This point is reached upon expanding the structure to host 480 qubits. Further scaling becomes a straightforward replication of the 480 qubit module.

Referring now to figure 6, there is shown a schematic representation 600 of a section of an architecture comprising a plurality of quantum bits. A unit cell 602

used to operate a single quantum bit is shown. The unit cell has two sections 604 and 606. Section 604 is used to form, tune and calibrate the qubit. Section 606 is used to perform quantum operations such readout, control and
5 coupling of qubits. Unit cell 602 represents a top view of the structure described with reference to figure 3.

Unit cell 602 has an 8 by 6 footprint. Using the available 7 nm CMOS fabrication node, for example, unit cell 402 would have a size of 42 nm by 56 nm. These dimensions
10 allow the integration of a large number of qubits on a single chip providing potential for substantial scalability of the architecture. Suitable quantum dot qubits with comparable dimensions have been realised by the Applicants and are described in PCT Application n.
15 PCT/AU2014/000596.

Referring now to figure 7 there is shown a diagram 700 of a portion of an architecture realised in accordance with embodiments. Diagram 700 shows, in a schematic way, the connections between the control lines, the control members
20 and the processing elements.

In one embodiment, the processing elements in structure 700 can be initialised as follows: first all the qubits are initialized using bit-lines 724, word-lines 726 and data-lines 728, which are connected to respective control
25 members' transistor channels and electrodes (shown in figure 5 as reference numerals 520 and 514 respectively). The sequence starts by setting the first word-line 726 to high. Then the respective bit-line 724 is turned high and the qubit located at the intersection of the bit-line and
30 the word-line can be tuned using a voltage applied to the corresponding data-line 728.

After initialization, the bit-lines 724 are turned off. This process can be performed for individual bit-lines or for all the qubits disposed along one word-line 726, by cycling the bit-lines 726 together, such that row after
5 row can be set, or operating all the bit-lines simultaneously. These sequences can be routinely performed.

Operation of the qubits can be implemented using bit-lines 730, word-lines 732 and data-lines 734, which are
10 connected to respective control members' transistor channels and electrodes (shown in figure 5 as reference numerals 570 and 552 respectively). To perform qubit operations one or more of the bit-lines 730 and one or more of word-lines 732 can be set to a high voltage
15 (digital high state) to select a plurality of qubits positioned at the intersections of these lines. Q-qubit operations can then be performed by applying appropriate voltage signals to the corresponding data-line.

A possible way to operate qubits simultaneously using
20 architecture 700 comprises the following steps:

begin by setting a high state to the word-lines 726;

setting to high the bit-lines 724 to the qubits that need to be addressed;

25 turning the respective word-lines 726 to the state low,

turning the bit-lines 724 to low;

turning the operation word-lines 732 to high for the qubits that need to be operated;

setting the respective bit-lines 730.

The process is continued until all the qubits are set to the correct state. When the data-lines 734 are turned to high, they only connect to the qubits that need to be addressed and a qubit operation can be performed.

The initialisation of the qubits can be done very fast, with a time that depends on the size of the 2D array, but well within the coherence time of the qubits. During this time, the qubits could be operated so as to echo out any environmental noise, specifically low-frequency noise. Furthermore, the process of setting the bit-lines 524 for the qubits to be addressed can be used for both single- and two-qubit operations.

In embodiments, a plurality of switches and capacitors could be used per qubit. Additionally, multiple switches and capacitors can be used to control the qubit coupling.

The switches that connect to the qubits also allow individual tuning and definition of each qubit. Advantages of this architecture are provided by the periodic and fast tuning capabilities.

After turning the corresponding control lines to low, the charge stored on the respective electrodes 514 or 552 of figure 5 keeps the qubits tuned to the desired state. A similar type of charge storage capacitor is well established in DRAM memory systems. We note that the voltage on the electrodes 514 and 552 of figure 5 can tune the number of electrons in each dot, as well as the

electric field that determines the effective g-factor and associated resonance frequency, and also the location of the quantum dot. The qubit coupling can be controlled either via a detuning created by multiple electrodes, or
5 using the direct tunnel coupling set by a single electrode (552 in figure 5).

In some embodiments, the state of the qubits can be read out by using Pauli spin blockade or by the Zeeman splitting energy. This type of readout can be implemented
10 by using neighbouring dots, or using electron reservoirs. The state of the qubits can also be read out using dispersive readout techniques, such as those described in Colless et al., Phys. Rev. Lett. v110, p046805 (2013).

In the architecture described herein, the resonance
15 frequency of the qubit state for dispersive readout can be engineered via on-chip capacitances, such that each qubit along a row has an independent resonance frequency. By multiplexing these frequencies it is possible to readout the state of all qubits along one row simultaneously.

20 The addressability of the qubits in architecture 700 opens the prospects for scalability, and the integration of many qubits on a single chip, with global AC magnetic fields applied via a cavity resonator or on-chip transmission lines to realise single qubit operations.

25 Architecture 700 can be realised using poly-silicon electrodes and complementary metal-oxide-semiconductor (CMOS) manufacturing technologies that are currently used to fabricate more than one billion transistors on a single chip.

The architecture described demonstrates that an array of single electron spins confined to quantum dots in isotopically purified silicon can be controlled using a limited number of control lines. We have shown that the often argued compatibility of silicon spin qubits with standard CMOS technology is non-trivial. However, in the case of quantum dot qubits, the fabrication can be made consistent with standard CMOS technology and be scaled up to contain thousands to potentially even millions of qubits, while the resulting transistor overhead constrains the minimum qubit size to within experimentally demonstrated qubits. The combination of ESR-control, exchange coupling and dispersive readout enables to perform surface code operations with this platform. A key advantage is the possibility of global qubit control, such that many qubits can be addressed within the qubit coherence time.

The architecture for control and operation as presented is highly generic and can be implemented in a number of platforms, such as spin qubits based on SiGe, including single spin qubits, singlet-triplet qubits, exchange-only or hybrid qubits. While the fabrication on a single SOI wafer has been presented herein, a more advanced and complex fabrication process could include multiple stacked layers to allow for more complex classical electronics per qubit, or for a separate control circuit that is purely dedicated for calibration and stability.

The operation temperature of the architecture can range from zero Kelvin up to liquid Helium temperatures. Operation at liquid Helium temperatures provides larger cooling power, whereas operation in the milli-kelvin

regime provides smaller charge noise and smaller thermal broadening. The specific operation of the qubit system in different embodiments is related to the operation temperature. The possibility of operation at higher
5 temperatures is a strong benefit of this architecture in relation to prior art systems (e.g. superconducting circuits) and mitigates an important problem related to cooling.

The dynamic power dissipation of CMOS inverters takes up
10 about 80% of the total power dissipation in technology nodes up to 0.35 μm , and dynamic power dissipation is even more important at low temperatures. As the dynamic power dissipation is proportional to capacitance, supply voltage, average number of transitions per clock cycle
15 with a given frequency, and the frequency, the power dissipation can easily reach 1 Watt when millions of qubits are operated. Operation at liquid helium temperatures, above 1 Kelvin, is therefore a strong benefit. Alternatively, low voltage switches could be
20 used, which would benefit from the low temperature operation.

The silicon-metal-oxide-semiconductor dot qubits described herein are particularly suited to be operated at higher temperatures, as other states that could potentially
25 couple to the qubit states are lifted to higher energies. For example, the strong electrical confinement and corresponding large electric fields, together with the sharp boundary at the interface, leads to orbital states that are many milli-electronvolts (meV) away from the
30 qubit states. Additionally, the valley states are also lifted to energies that can be as large as one milli-

electronvolt (meV), such that qubit control and readout is possible up to several Kelvin.

Depending on the operation mechanism of the qubit system, the control lines have to support a certain range of
5 frequencies. Specifically, the design in figure 5 is suitable for operation with lines that support up to ~GHz, consistent with current CMOS technology standards. In the case of operation using electron-spin-resonance, one large cavity that supports frequencies in the tens of gigahertz
10 can be used. Ground planes are used to avoid capacitive cross talk and are realized such that they have the required coupling to each gate.

The realisation of dense and large 2D arrays of qubits is facilitated by embodiments of the present disclosure.
15 Additional spaces that allow, for example, more switches per qubit can be realized by changing the readout methods. For example, two or more dots could be used to facilitate the dispersive readout.

The architecture described herein could work as a single
20 large 2D array. Alternatively, the 2D array could be used to construct very large 2D arrays by combining smaller 2D arrays, or multi-qubit modules. The multi-qubit modules could be coupled using 2D arrays as well, or long-range coupling could be realized using methods like
25 superconducting resonators, spin-buses, or other mechanisms that provide the required long-distance coupling.

In the above embodiments the dielectric is silicon dioxide. The invention is not limited to this dielectric,

however, and other dielectrics, such as Hafnium-oxide, may be utilised in place of SiO₂.

In some of the embodiments described above, the quantum state affected is spin. The "spin" is the spin of a
5 single electron, or the spin of a single hole, or may be the composite spin of two or more electrons or holes, for qubits utilising two or more electrons or holes.

The above embodiments describe qubits formed by one, two or three quantum dots. Qubits may be formed by four or
10 more quantum dots. The invention is not limited to one, two or three quantum dot qubits.

Throughout this specification the term "effective g-factor" is used broadly to indicate a ratio between the spin resonance frequency for the spin system and the DC
15 magnetic field.

The term "comprising" (and its grammatical variations) as used herein are used in the inclusive sense of "having" or "including" and not in the sense of "consisting only of".

It will be appreciated by persons skilled in the art that
20 numerous variations and/or modifications may be made to the invention as shown in the specific embodiments without departing from the spirit or scope of the invention as broadly described. The present embodiments are, therefore, to be considered in all respects as
25 illustrative and not restrictive.

The Claims Defining the Invention are as Follows:

1. An advanced processing apparatus, comprising:

a plurality of quantum processing elements
arranged in a 2D matrix; each processing element
5 comprising silicon and a dielectric material forming an
interface and an electrode arrangement suitable to confine
one or more electrons or holes in the silicon, for each
quantum processing element, to form a quantum dot operable
as a qubit;

10 a plurality of interconnected control members
forming a matrix of control members; each control member
comprising a silicon metal-oxide-semiconductor transistor
disposed above a respective quantum processing element and
configured to interact with the electrode arrangement to
15 perform quantum operations with the processing element;
and

a plurality of control lines; each control line
being connected to a plurality of control members via the
metal-oxide-semiconductor transistors to enable
20 simultaneous operation of a plurality of processing
elements.

2. The apparatus of claim 1 wherein the quantum operations
comprise any one of initialisation, quantum control and
readout of the processing element.

25 3. The apparatus of claim 1 or claim 2 wherein the
electrode arrangement comprises one or more electrodes
which are controllable to form the quantum dot and operate
the quantum dot as a qubit.

4. The apparatus of any one of the preceding claims wherein the processing elements are arranged in the 2D matrix at an interface which is formed between a silicon layer and a dielectric layer; the interface, the silicon layer and the dielectric layer being shared by the processing elements.

5. The apparatus of claim 4 wherein the electrode arrangement is disposed onto the dielectric layer and the quantum dot is formed within the silicon layer and in proximity of the interface.

6. The apparatus of any one of the claims 4 or claim 5 wherein each control line is arranged along a row or a column of the 2D matrix of processing elements and is capable of interacting with all the processing elements disposed along the row or column.

7. The apparatus of claim 6 wherein each control line is connected with one or more of the control members associated with the processing element.

8. The apparatus of any one of the preceding claims wherein each processing element is associated with at least two control members.

9. The apparatus of claim 8 wherein a first control member is arranged to provide a biasing voltage to form the quantum dot and a second control member is arranged to operate the quantum dot as a qubit.

10. The apparatus of claim 9 wherein the biasing voltage is selected to calibrate the processing element in relation to other processing elements of the matrix.

11. The apparatus of any one of claim 9 or claim 10 wherein a first set of control lines is arranged in a manner such that the biasing voltage is applicable to the first control member of selected processing elements to form the quantum dots.

12. The apparatus of any one of claims 8 to 11 wherein the control lines are arranged in a manner such that a specific processing element can be selected for quantum operation.

13. The apparatus of any one of claims 8 to 12 wherein the control lines are arranged in a manner such that a control voltage is applicable to the second control member of the selected processing elements to operate the qubits.

14. The apparatus of any one of the preceding claims wherein the electrode arrangement is operable to form the quantum dot and tune the quantum dot so that the energy at which the state of the qubit is affected can be adjusted over a range of energy values.

15. The apparatus of any one of the preceding claims wherein the electrode arrangement is operable to control a quantum property of the quantum dot to operate the quantum dot as a qubit.

16. The apparatus of claim 14 or claim 15 wherein the qubit logic states are controlled by voltages applied to the electrode arrangement to tune an exchange interaction between spins of electrons or holes of the quantum dots.

17. The apparatus of claim 14 or claim 15 wherein the qubit logic states are controlled by voltages applied to the electrode arrangement to tune a capacitive interaction

between one or more electrons or holes of the quantum dots.

18. The apparatus of any one of claims 14 to 17 wherein the electrode arrangement is operable to tune the electron
5 or hole spin resonance frequency of the quantum dot.

19. The apparatus of claim 18 wherein the electrode arrangement is operable to electrically drive the electron or hole spin resonance frequency of the quantum dot.

20. An advanced processing apparatus comprising a
10 plurality of multi-qubit modules; each multi-qubit module comprising an apparatus in accordance with any one of the preceding claims.

21. The apparatus of claim 20 wherein the plurality of multi-qubit modules are interconnected by superconducting
15 resonators or spin-buses.

22. A system comprising an advanced processing apparatus in accordance with any one of claims 1 to 21 and a classical computing apparatus, wherein the classical computing apparatus controls the advanced processing
20 apparatus to perform a quantum algorithm.